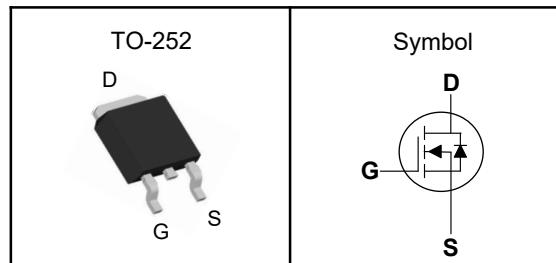


N-Channel Enhancement Mode MOSFET

Features

- Low R_{dson} for low conduction loss
- Reliable and Rugged
- ROHS Compliant & Halogen-Free

Pin Description



Applications

- Power Management in Desktop Computer
- DC/DC Converters

V_{DSS}	70	V
$R_{DS(ON)-Typ}$	5.2	$\text{m}\Omega$
I_D	70	A

Absolute Maximum Ratings ($T_J=25^\circ\text{C}$, Unless Otherwise Noted)

Symbol	Parameter	Rating	Unit
V_{DSS}	Drain-Source Voltage	70	V
V_{GSS}	Gate-Source Voltage	± 20	V
T_J	Maximum Junction Temperature	-55 to 150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
E_{AS}	Single Pulse Avalanche Energy ^③	168	mJ
$I_{DM}^{①}$	Pulse Drain Current Tested	280	A
I_D	Continuous Drain Current	$T_c=25^\circ\text{C}$	A
P_D	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	W

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient ₁ (Max)	55	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance Junction-Case ₁	1.3	$^\circ\text{C}/\text{W}$

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C .

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz.

N-Channel Enhancement Mode MOSFET
Electrical Characteristics ($T_J=25^\circ\text{C}$, Unless Otherwise Noted)

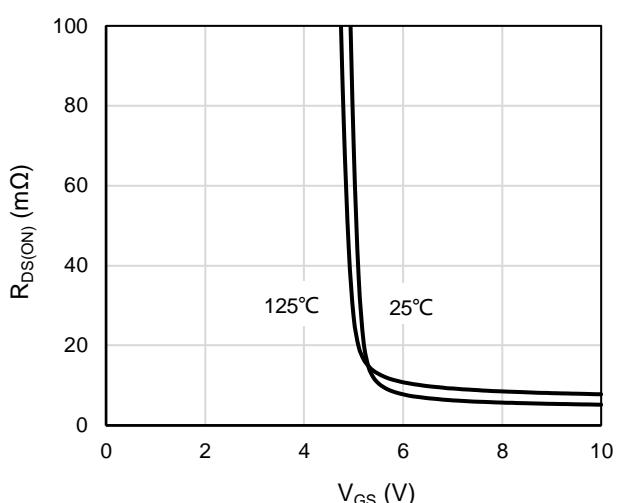
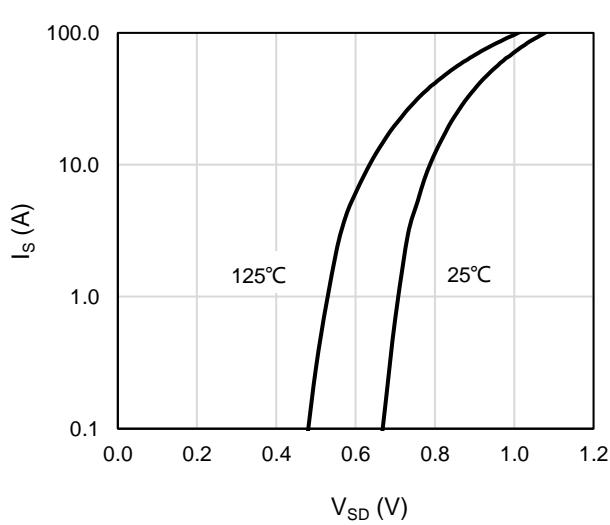
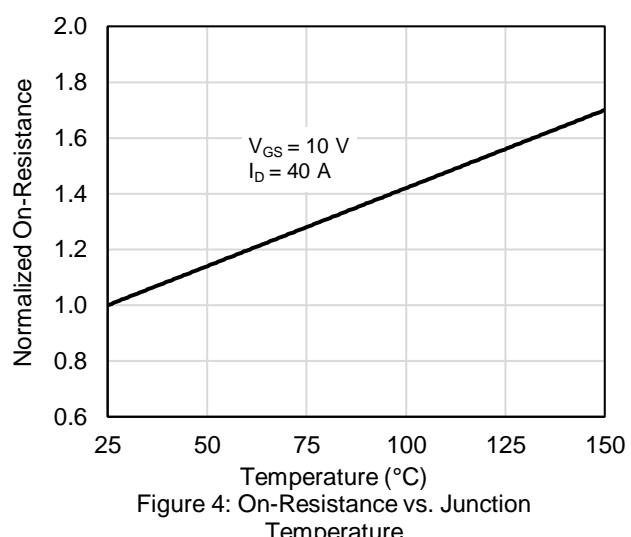
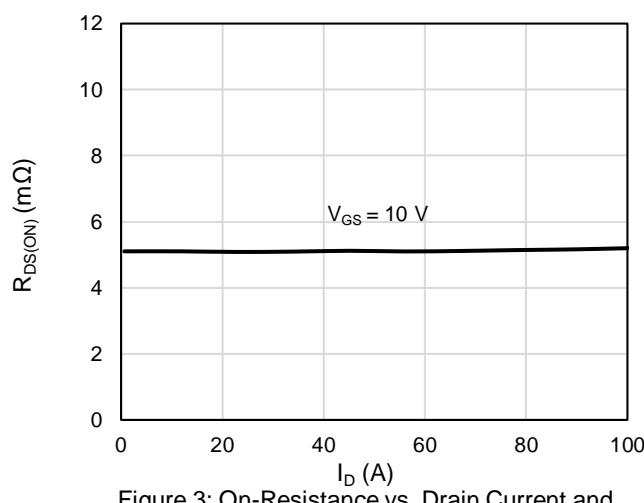
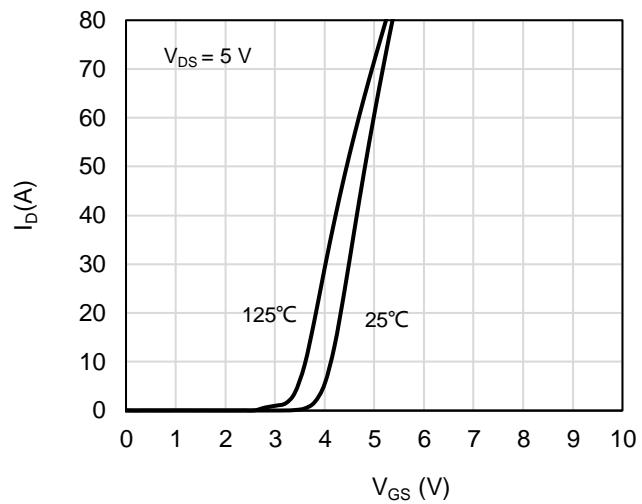
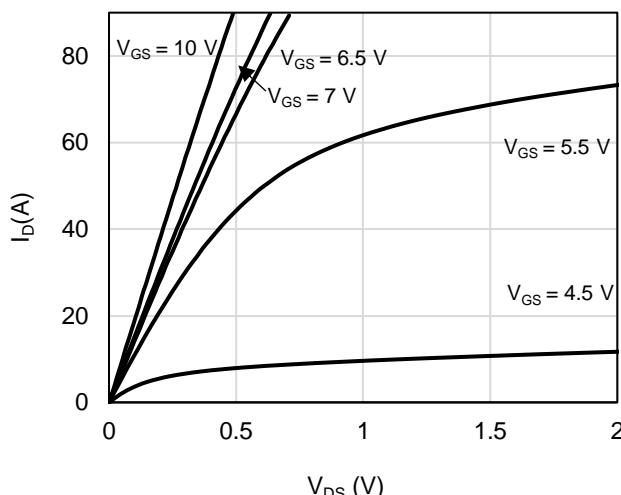
Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_D=250\text{mA}$	70	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=70\text{V}$, $V_{\text{GS}}=0\text{V}$	---	---	1	μA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_D=250\mu\text{A}$	2.0	---	4.0	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
$R_{\text{DS(ON)}}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$, $I_D=40\text{A}$	---	5.2	6.0	$\text{m}\Omega$
Dynamic Characteristics^⑤						
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=35\text{V}$, Freq.=1MHz	---	2056	---	pF
C_{oss}	Output Capacitance		---	716	---	
C_{rss}	Reverse Transfer Capacitance		---	50	---	
$T_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=35\text{V}$, $V_{\text{GS}}=10\text{V}$, $R_G=0.9\Omega$, $I_D=40\text{A}$	---	14	---	nS
T_r	Turn-on Rise Time		---	48	---	
$T_{\text{d(off)}}$	Turn-off Delay Time		---	28.5	---	
T_f	Turn-off Fall Time		---	12	---	
Q_g	Total Gate Charge	$V_{\text{DS}}=35\text{V}$, $V_{\text{GS}}=10\text{V}$, $I_D=40\text{A}$	---	37	---	nC
Q_{gs}	Gate-Source Charge		---	8.5	---	
Q_{gd}	Gate-Drain Charge		---	13	---	
Source-Drain Characteristics ($T_J=25^\circ\text{C}$)						
V_{SD}	Diode Forward Voltage ₂	$V_{\text{GS}}=0\text{V}$, $I_S=40\text{A}$, $T_J=25^\circ\text{C}$	---	---	1.3	V
t_{rr}	Reverse Recovery Time	$I_D=40\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$, $T_J=25^\circ\text{C}$	---	40	---	nS
Q_{rr}	Reverse Recovery Charge		---	28	---	nC

Note ④ : Pulse test (pulse width≤300us, duty cycle≤2%).

Note ⑤ : Guaranteed by design, not subject to production testing.

N-Channel Enhancement Mode MOSFET

Typical Characteristics



N-Channel Enhancement Mode MOSFET

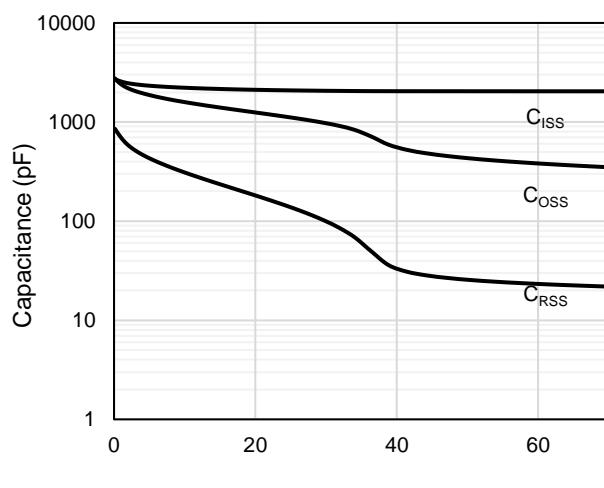


Figure 7: Capacitance Characteristics

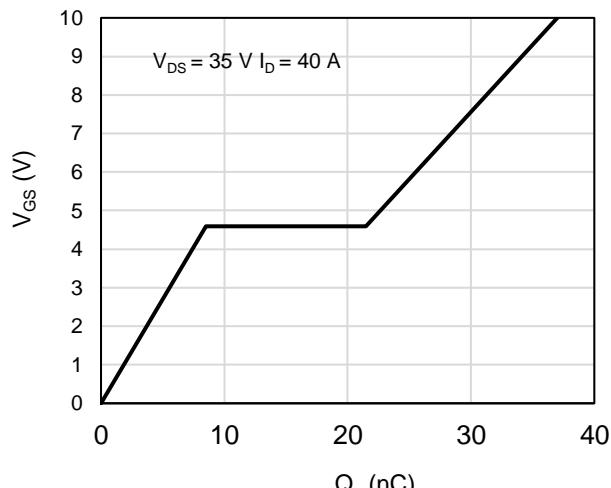


Figure 8: Gate-Charge Characteristics

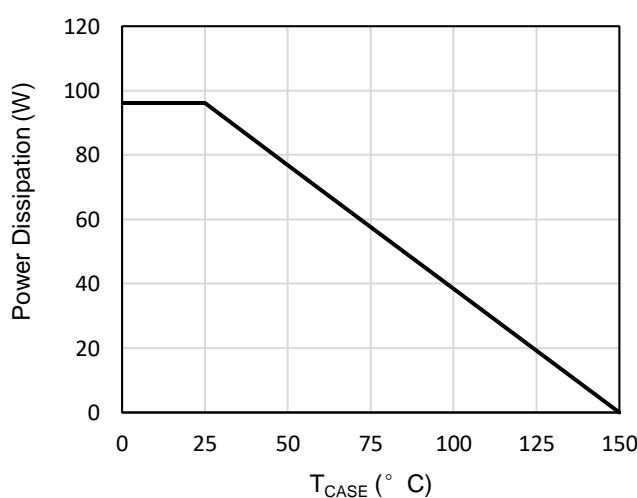


Figure 9: Power De-rating

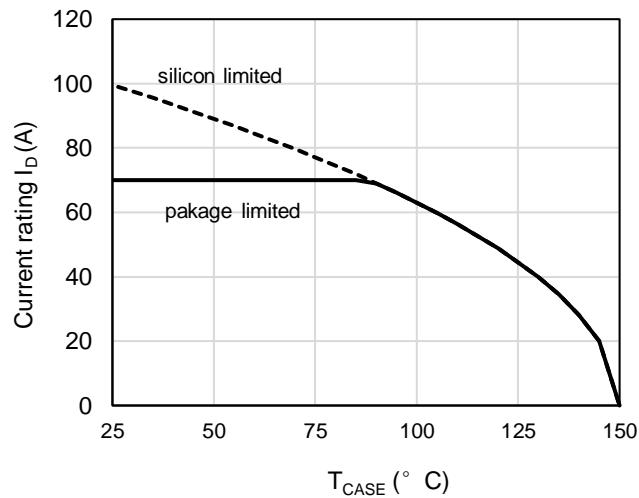


Figure 10: Current De-rating

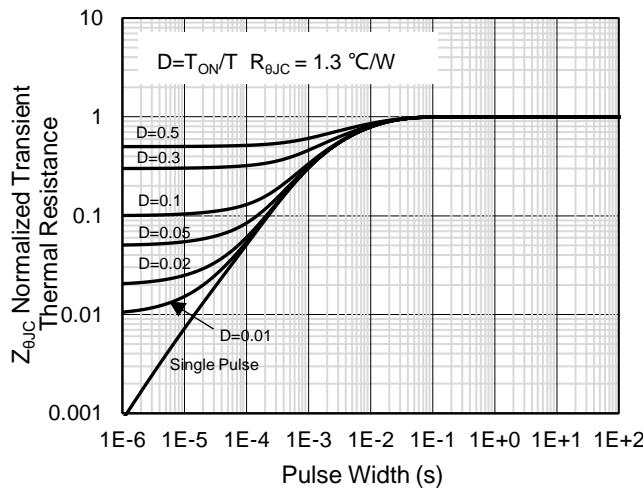


Figure 11: Normalized Maximum Transient Thermal Impedance

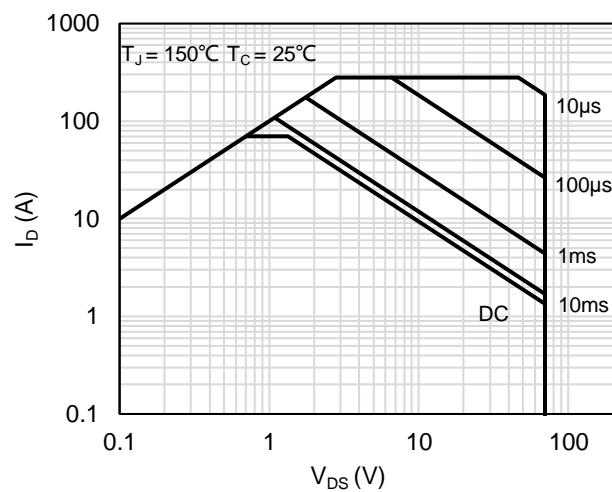
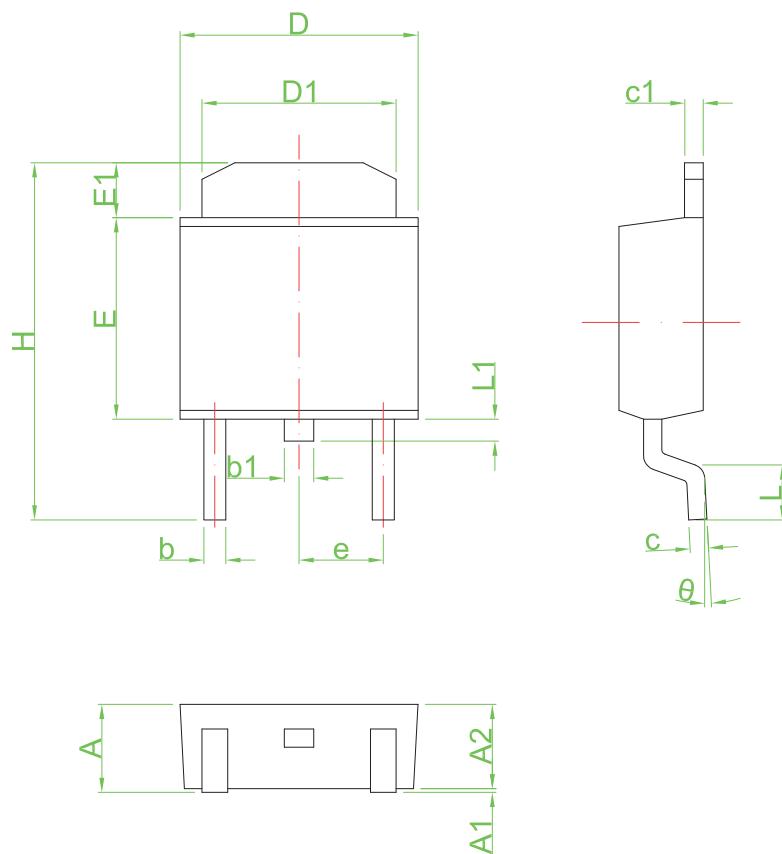


Figure 12: Maximum Forward Biased Safe Operating Area

N-Channel Enhancement Mode MOSFET
TO-252 Package Outline Dimensions


Symbol	Dimensions in Millimeters		Dimensions in Inches	
	Min	Max	Min	Max
A	2.25	2.65	0.089	0.104
A1	0.00	0.15	0.000	0.006
A2	2.20	2.40	0.087	0.094
b	0.50	0.70	0.020	0.028
b1	0.70	0.90	0.028	0.035
c	0.46	0.66	0.018	0.026
c1	0.46	0.66	0.018	0.026
D	6.30	6.70	0.248	0.264
D1	5.20	5.40	0.205	0.213
E	5.30	5.70	0.209	0.224
E1	1.40	1.60	0.055	0.063
H	9.40	9.90	0.370	0.390
e	2.30 TYP		0.09 TYP	
L	1.40	1.77	0.055	0.070
L1	0.50	0.70	0.020	0.028
θ	0°	8°	0°	8°